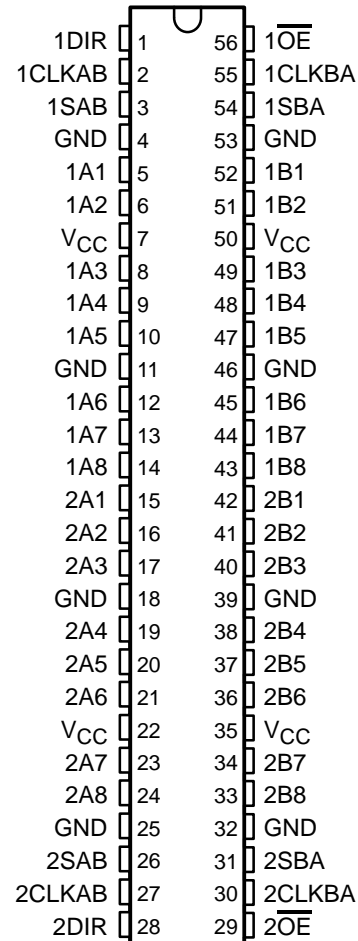


# 54AC16646, 74AC16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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- Members of the Texas Instruments *Widebus™* Family
- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- Flow-Through Architecture Optimizes PCB Layout
- Distributed  $V_{CC}$  and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1- $\mu$ m Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Pin Spacings

54AC16646 . . . WD PACKAGE  
74AC16646 . . . DL PACKAGE  
(TOP VIEW)



## description

The 'AC16646 are 16-bit bus transceivers that consist of D-type flip-flops and control circuitry, with 3-state outputs arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. The devices can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the bus transceivers and registers.

Output-enable ( $\overline{OE}$ ) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either register or in both. The select controls (SAB and SBA) can multiplex stored and real-time (transparent mode) data. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. DIR determines which bus receives data when  $\overline{OE}$  is active (low). In the isolation mode ( $\overline{OE}$  high), A data may be stored in one register and/or B data may be stored in the other register.

When an output function is disabled, the input function is still enabled and may be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The 74AC16646 is packaged in the TI shrink small-outline package, which provides twice the functionality of standard small-outline packages in the same printed-circuit-board area.

The 54AC16646 is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The 74AC16646 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .



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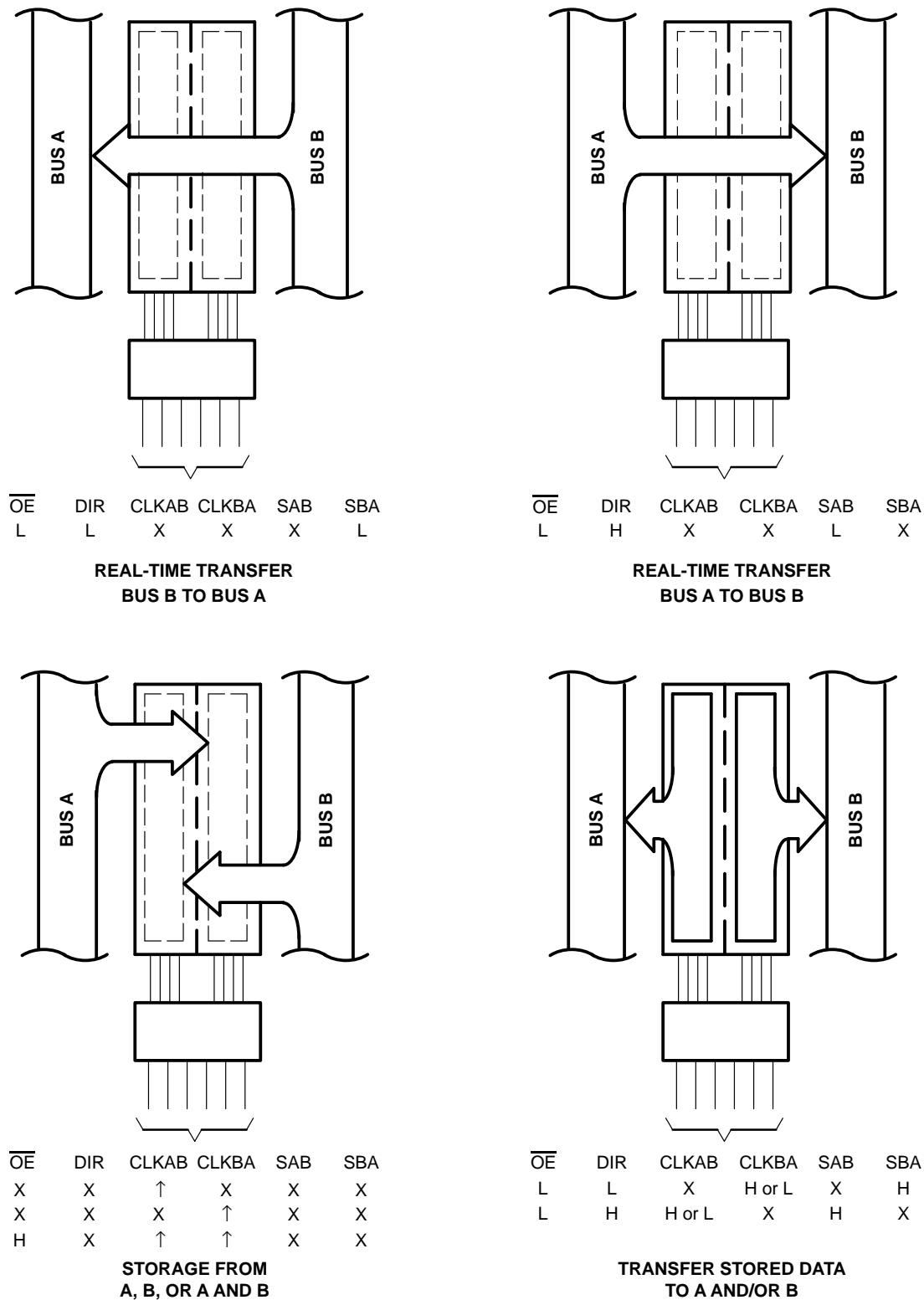
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**54AC16646, 74AC16646**  
**16-BIT BUS TRANSCEIVERS AND REGISTERS**  
**WITH 3-STATE OUTPUTS**

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**Figure 1. Bus-Management Functions**

**54AC16646, 74AC16646**  
**16-BIT BUS TRANSCEIVERS AND REGISTERS**  
**WITH 3-STATE OUTPUTS**

SCAS241A – MARCH 1990 – REVISED APRIL 1996

**FUNCTION TABLE**

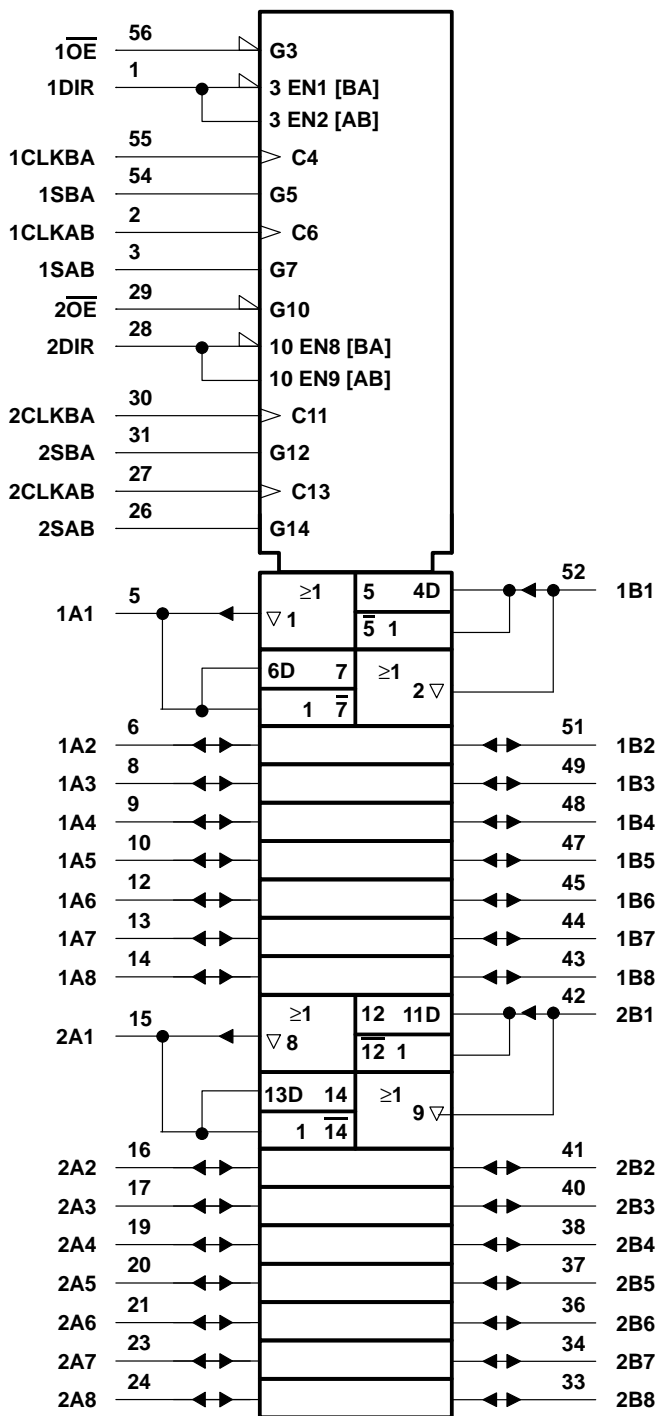
INPUTS						DATA I/O†		OPERATION OR FUNCTION
OE	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input	Input	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B Bus
L	H	H or L	X	H	X	Input	Output	Stored A data to bus

† The data-output functions may be enabled or disabled by various signals at OE or DIR. Data-input functions are always enabled, i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

# 54AC16646, 74AC16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

SCAS241A – MARCH 1990 – REVISED APRIL 1996

## logic symbol†

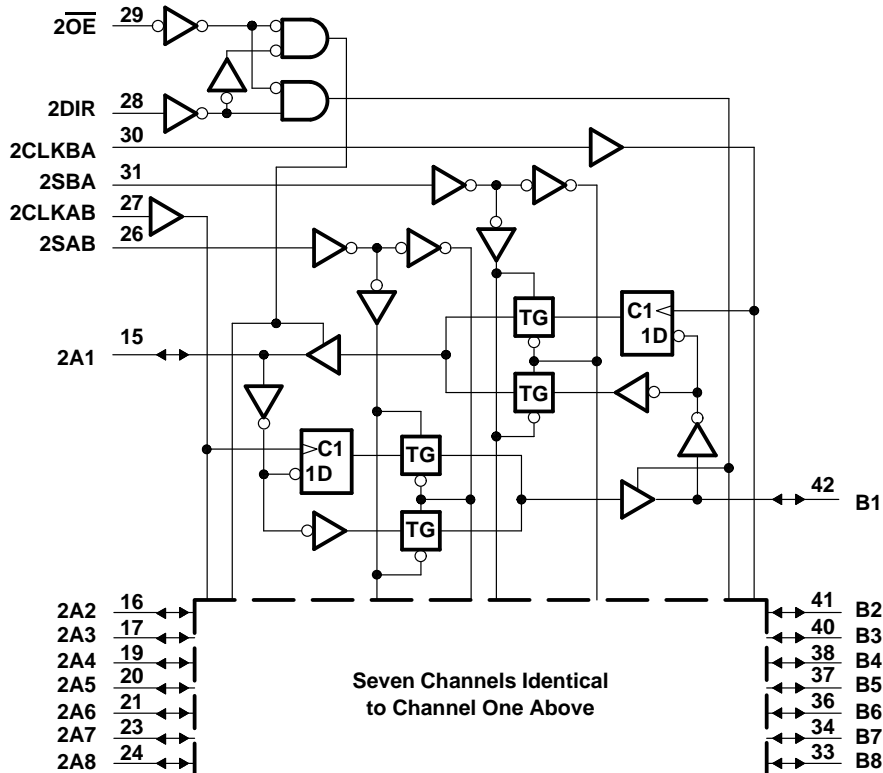
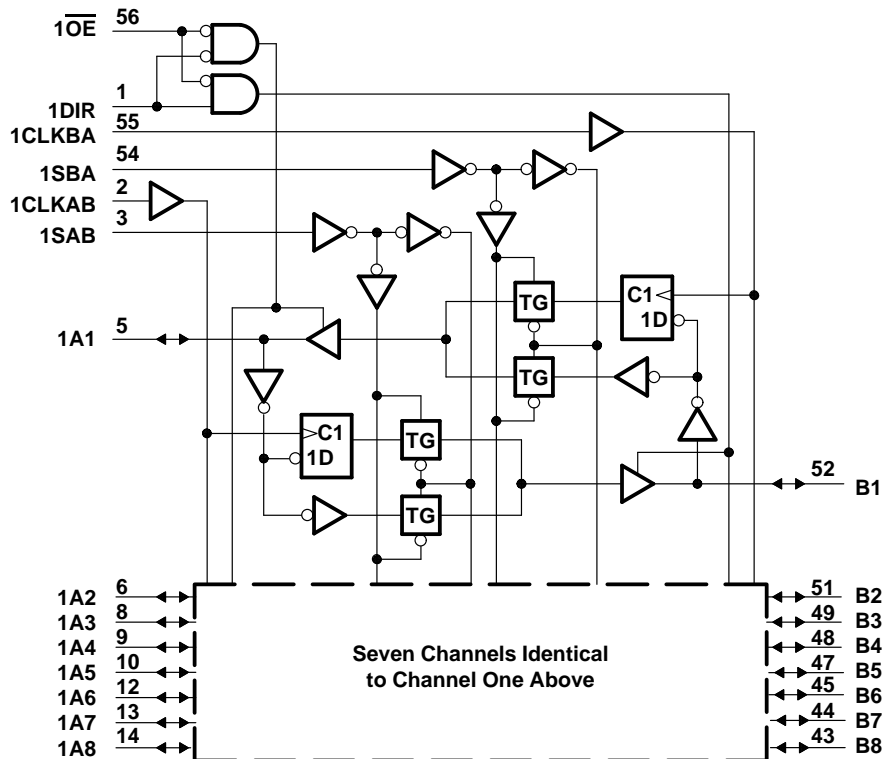


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

54AC16646, 74AC16646  
**16-BIT BUS TRANSCEIVERS AND REGISTERS  
 WITH 3-STATE OUTPUTS**

SCAS241A – MARCH 1990 – REVISED APRIL 1996

logic diagram (positive logic)



# 54AC16646, 74AC16646 16-BIT BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

SCAS241A – MARCH 1990 – REVISED APRIL 1996

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 50$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 400$ mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 2): DL package .....	1.4 W
Storage temperature range, $T_{stg}$ .....	$-65^\circ\text{C}$ to $150^\circ\text{C}$

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The maximum package power dissipation is calculated using a junction temperature of  $150^\circ\text{C}$  and a board trace length of 750 mils.

## recommended operating conditions

		54AC16646			74AC16646			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage (see Note 3)	3	5	5.5	3	5	5.5	V
$V_{IH}$	High-level input voltage	$V_{CC} = 3$ V		2.1	2.1		V	
		$V_{CC} = 4.5$ V		3.15	3.15			
		$V_{CC} = 5.5$ V		3.85	3.85			
$V_{IL}$	Low-level input voltage	$V_{CC} = 3$ V			0.9		V	
		$V_{CC} = 4.5$ V			1.35			
		$V_{CC} = 5.5$ V			1.65			
$V_I$	Input voltage	0		$V_{CC}$	0	$V_{CC}$	V	
$V_O$	Output voltage	0		$V_{CC}$	0	$V_{CC}$	V	
$I_{OH}$	High-level output current	$V_{CC} = 3$ V			-4		mA	
		$V_{CC} = 4.5$ V			-24			
		$V_{CC} = 5.5$ V			-24			
$I_{OL}$	Low-level output current	$V_{CC} = 3$ V			12		mA	
		$V_{CC} = 4.5$ V			24			
		$V_{CC} = 5.5$ V			24			
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	0	10	ns/V	
$T_A$	Operating free-air temperature	-55		125	-40	85	$^\circ\text{C}$	

NOTE 3: All  $V_{CC}$  and GND pins must be connected to the proper voltage power supply.

**54AC16646, 74AC16646**  
**16-BIT BUS TRANSCEIVERS AND REGISTERS**  
**WITH 3-STATE OUTPUTS**

SCAS241A – MARCH 1990 – REVISED APRIL 1996

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			54AC16646		74AC16646		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>	I <sub>OH</sub> = -50 μA	3 V	2.9			2.9		2.9	V	
		4.5 V	4.4			4.4		4.4		
		5.5 V	5.4			5.4		5.4		
	I <sub>OH</sub> = -4 mA	3 V	2.58			2.4		2.48		
		4.5 V	3.94			3.7		3.8		
		5.5 V	4.94			4.7		4.8		
	I <sub>OH</sub> = -50 mA <sup>†</sup>	5.5 V				3.85				
I <sub>OH</sub> = -75 mA <sup>†</sup>	5.5 V						3.85			
V <sub>OL</sub>	I <sub>OL</sub> = 50 μA	3 V			0.1		0.1		V	
		4.5 V			0.1		0.1			
		5.5 V			0.1		0.1			
	I <sub>OL</sub> = 12 mA	3 V			0.36		0.5			0.44
		4.5 V			0.36		0.5			0.44
		5.5 V			0.36		0.5			0.44
	I <sub>OL</sub> = 50 mA <sup>†</sup>	5.5 V				1.65				
I <sub>OL</sub> = 75 mA <sup>†</sup>	5.5 V						1.65			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1		±1		μA	
I <sub>OZ</sub> <sup>‡</sup>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.5		±10		μA	
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V			8		160		μA	
C <sub>i</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V			4.5				pF	
C <sub>o</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5 V			16				pF	

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

<sup>‡</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

**timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 2)**

		T <sub>A</sub> = 25°C		54AC16646		74AC16646		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency	0	65	0	65	0	65	MHz
t <sub>w</sub>	Pulse duration, CLKAB or CLKBA high or low	7		7		7		ns
t <sub>su</sub>	Setup time, A before CLKAB <sup>↑</sup> or B before CLKBA <sup>↑</sup>	6.5		6.5		6.5		ns
t <sub>h</sub>	Hold time, A after CLKAB <sup>↑</sup> or B after CLKBA <sup>↑</sup>	1		1		1		ns

**timing requirements over recommended operating free-air temperature range, V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted) (see Figure 2)**

		T <sub>A</sub> = 25°C		54AC16646		74AC16646		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency	0	75	0	75	0	75	MHz
t <sub>w</sub>	Pulse duration, CLKAB or CLKBA high or low	6.5		6.5		6.5		ns
t <sub>su</sub>	Setup time, A before CLKAB <sup>↑</sup> or B before CLKBA <sup>↑</sup>	5		5		5		ns
t <sub>h</sub>	Hold time, A after CLKAB <sup>↑</sup> or B after CLKBA <sup>↑</sup>	1		1		1		ns

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**54AC16646, 74AC16646**  
**16-BIT BUS TRANSCEIVERS AND REGISTERS**  
**WITH 3-STATE OUTPUTS**

SCAS241A – MARCH 1990 – REVISED APRIL 1996

**switching characteristics over recommended operating free-air temperature range,**  
**V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted) (see Figure 2)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			54AC16646		74AC16646		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			65			65		65		MHz
t <sub>PLH</sub>	A or B	B or A	3.4	9.3	13.2	3.4	15.7	3.4	14.8	ns
t <sub>PHL</sub>			3.6	10	13.4	3.6	15.1	3.6	4.5	
t <sub>PZH</sub>	$\overline{OE}$	A or B	3.8	10.5		3.8	17.6	3.8	16.4	ns
t <sub>PZL</sub>			4.8	13.9		4.8	22.1	4.8	20.9	
t <sub>PHZ</sub>	$\overline{OE}$	A or B	4.4	7.6		4.4	11	4.4	10.7	ns
t <sub>PLZ</sub>			4	7		4	10.4	4	10.1	
t <sub>PLH</sub>	CLKBA or CLKAB	A or B	4.7	12.1		4.7	19.9	4.7	18.7	ns
t <sub>PHL</sub>			4.8	12.2		4.8	18.8	4.8	18	
t <sub>PLH</sub>	SAB or SBA† (with A or B high)	A or B	4.7	12		4.7	19.9	4.7	18.5	ns
t <sub>PHL</sub>			4.5	11.4		4.5	17.2	4.5	16.4	
t <sub>PLH</sub>	SBA or SAB† (with A or B low)	A or B	4	10.5		4	17.3	4	16.3	ns
t <sub>PHL</sub>			5.2	13.3		5.2	20.3	5.2	19.3	
t <sub>PZH</sub>	DIR	A or B	3.6	10.3		3.6	17.9	3.6	16.8	ns
t <sub>PZL</sub>			4.7	13.5		4.7	22.1	4.7	20.8	
t <sub>PHZ</sub>	DIR	A or B	4.6	7.8		4.6	11.6	4.6	11.2	ns
t <sub>PLZ</sub>			3.9	7		3.9	11	3.9	10.6	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

**switching characteristics over recommended operating free-air temperature range,**  
**V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted) (see Figure 2)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	T <sub>A</sub> = 25°C			54AC16646		74AC16646		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f <sub>max</sub>			75			75		75		MHz
t <sub>PLH</sub>	A or B	B or A	2.9	5.5	8.5	2.9	10.1	2.9	9.5	ns
t <sub>PHL</sub>			2.9	5.7	8.9	2.9	10.1	2.9	9.7	
t <sub>PZH</sub>	$\overline{OE}$	A or B	3.1	6.1	9.4	3.1	11.1	3.1	10.5	ns
t <sub>PZL</sub>			4.1	7.3	11	4.1	12.9	4.1	12.2	
t <sub>PHZ</sub>	$\overline{OE}$	A or B	4	6.1	8.4	4	9.1	4	8.9	ns
t <sub>PLZ</sub>			3.8	5.7	8	3.8	8.9	3.8	8.6	
t <sub>PLH</sub>	CLKBA or CLKAB	A or B	3.9	7	10.8	3.9	12.8	3.9	12.1	ns
t <sub>PHL</sub>			3.9	7.1	10.8	3.9	12.5	3.9	11.9	
t <sub>PLH</sub>	SAB or SBA† (with A or B high)	A or B	4	7.4	11.1	4	13.4	4	12.5	ns
t <sub>PHL</sub>			3.6	6.7	10.2	3.6	11.8	3.6	11.2	
t <sub>PLH</sub>	SBA or SAB† (with A or B low)	A or B	3.3	6.1	9.5	3.3	11.2	3.3	10.6	ns
t <sub>PHL</sub>			4.3	8	11.7	4.3	13.9	4.3	13.1	
t <sub>PZH</sub>	DIR	A or B	3	5.9	9.6	3	11.6	3	10.9	ns
t <sub>PZL</sub>			3.6	7	11.1	3.6	12.9	3.6	12.2	
t <sub>PHZ</sub>	DIR	A or B	4	6.2	8.8	4	9.6	3	9.4	ns
t <sub>PLZ</sub>			3.7	5.7	8.2	3.7	9	3.7	8.8	

† These parameters are measured with the internal output state of the storage register opposite that of the bus input.

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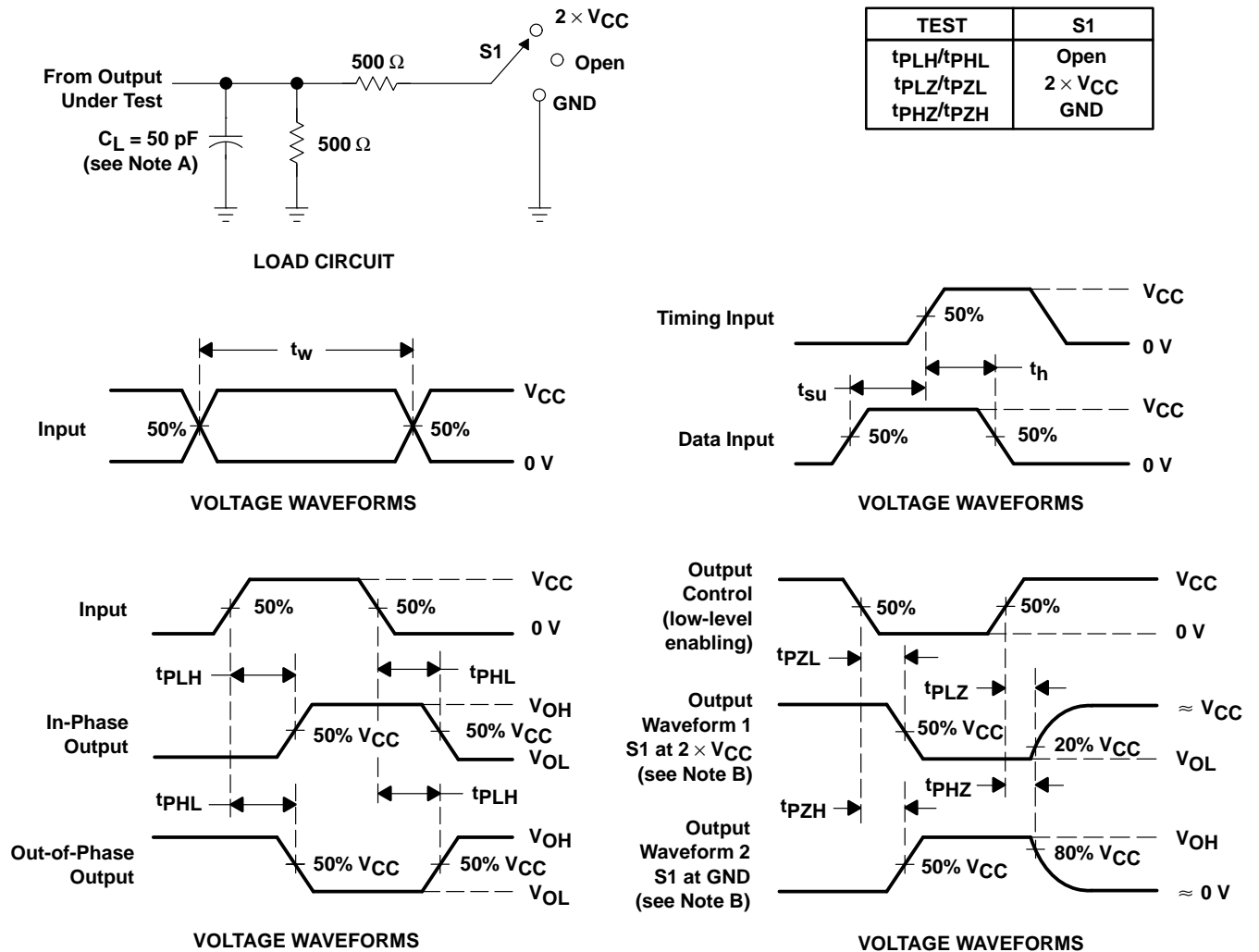
54AC16646, 74AC16646  
16-BIT BUS TRANSCEIVERS AND REGISTERS  
WITH 3-STATE OUTPUTS

SCAS241A – MARCH 1990 – REVISED APRIL 1996

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
$C_{pd}$	Power dissipation capacitance	Outputs enabled	62	pF
		Outputs disabled		

PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r = 3\text{ ns}$ ,  $t_f = 3\text{ ns}$ .
  - D. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms

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